ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pa	IPC. Bannockł	ourn. Illinois. A	ll rights reserved untions.	inder both	This docume level parts, t	ent is a declarati he declaration e	on of the su	ibstances v s all lower	within the manufactur level materials for w	rer listed it hich the m	em. Note: anufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type ³ Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials				als and Mi	g Informa	tion			
upplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Response Date*				
onsemi											2024-05-21			
Contact Name Title - Contact			et	I			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product En			duct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Rep			- Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product E			duct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date Version Manuf		Ianufacturing Site	e Weigh		UOM	Unit Type		
	QTLP61	QTLP610CPDTR PHOTOTR R_		_ANGLE SMD T&R		2024-05-21		E	EVERLGFG		6.58	mg	Each	
Ianufacturing Proccess Informa	ntion													
Terminal Plating / Grid Array M	aterial 7	Ferminal Base	loy J-STD-020 MSL Rati		Rating	Peak Proc	Peak Process Body Temperati		ure Max Time at Peak Tempe		are Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Allo		CU Alloy	3			260		С	30	second	is 3			
omments														
TTENTION: MSL 3 Rated item require	es Bake and D	Dry Pack (after	electrical test)											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.05	mg	Supplier	Silicon (Si)	7440-21-3		0.05	mg
Die Attach	0.05	mg	Supplier	Silver (Ag)	7440-22-4		0.045	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.005	mg
Lead Frame	19.698	mg	Supplier	Silver (Ag)	7440-22-4		0.006	mg
			Supplier	Zinc (Zn)	7440-66-6		0.026	mg
			Supplier	Iron (Fe)	7439-89-6		0.473	mg
			Supplier	Copper (Cu)	7440-50-8		19.193	mg
Mold Compound-Black	25.772	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		12.886	mg
			Supplier	2,4,6-Tris[Bis(Methoxymethyl)Amino]- 1,3,5-Triazine	3089-11-0		12.886	mg
Plating	1.0	mg	Supplier	Tin (Sn)	7440-31-5		1	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg